

TC74HC139AP, TC74HC139AF, TC74HC139AFN

Dual 2-to-4 Line Decoder

The TC74HC139A is a high speed CMOS 2-to-4 LINE DECODER/DEMULTIPLEXER fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The active low enable input can be used for gating or it can be used as a data input for demultiplexing applications.

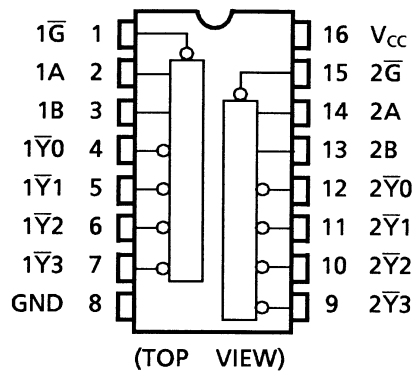
When the enable input is held "H", all four outputs are fixed at a high logic level independent of the other inputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

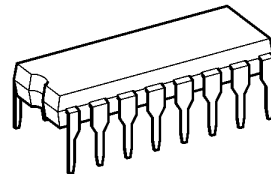
- High speed: $t_{pd} = 16 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu\text{A (max)}$ at $T_a = 25^\circ\text{C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC} \text{ (min)}$
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: $|I_{OH}| = I_{OL} = 4 \text{ mA (min)}$
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: $V_{CC} \text{ (opr)} = 2 \sim 6 \text{ V}$
- Pin and function compatible with 74LS139

Pin Assignment



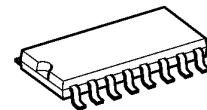
Note: xxxFN (JEDEC SOP) is not available in Japan.

TC74HC139AP

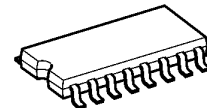


DIP16-P-300-2.54A

TC74HC139AF

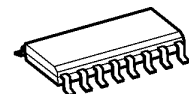


SOP16-P-300-1.27A



SOP16-P-300-1.27

TC74HC139AFN



SOL16-P-150-1.27

Weight

DIP16-P-300-2.54A	: 1.00 g (typ.)
SOP16-P-300-1.27A	: 0.18 g (typ.)
SOP16-P-300-1.27	: 0.18 g (typ.)
SOL16-P-150-1.27	: 0.13 g (typ.)

IEC Logic Symbol



Truth Table

Inputs			Outputs				Selected Output
Enable	Select		$\bar{Y}0$	$\bar{Y}1$	$\bar{Y}2$	$\bar{Y}3$	
$\bar{G}$	B	A					
H	X	X	H	H	H	H	None
L	L	L	L	H	H	H	$\bar{Y}0$
L	L	H	H	L	H	H	$\bar{Y}1$
L	H	L	H	H	L	H	$\bar{Y}2$
L	H	H	H	H	H	L	$\bar{Y}3$

X: Don't care

Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	-0.5~7	V
DC input voltage	V_{IN}	-0.5~ $V_{CC} + 0.5$	V
DC output voltage	V_{OUT}	-0.5~ $V_{CC} + 0.5$	V
Input diode current	I_{IK}	±20	mA
Output diode current	I_{OK}	±20	mA
DC output current	I_{OUT}	±25	mA
DC V_{CC} /ground current	I_{CC}	±50	mA
Power dissipation	P_D	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T_{stg}	-65~150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Note 2: 500 mW in the range of $T_a = -40^{\circ}\text{C} \sim 65^{\circ}\text{C}$. From $T_a = 65^{\circ}\text{C}$ to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

Recommended Operating Conditions (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2~6	V
Input voltage	V_{IN}	0~ V_{CC}	V
Output voltage	V_{OUT}	0~ V_{CC}	V
Operating temperature	T_{opr}	-40~85	°C
Input rise and fall time	t_r, t_f	0~1000 ($V_{CC} = 2.0$ V) 0~500 ($V_{CC} = 4.5$ V) 0~400 ($V_{CC} = 6.0$ V)	ns

Note: The recommended operating conditions are required to ensure the normal operation of the device.
Unused inputs must be tied to either VCC or GND.

Electrical Characteristics
DC Characteristics

Characteristics	Symbol	Test Condition		V _{CC} (V)	Ta = 25°C			Ta = -40~85°C		Unit
					Min	Typ.	Max	Min	Max	
High-level input voltage	V _{IH}	—		2.0 4.5 6.0	1.50 3.15 4.20	— — —	— — —	1.50 3.15 4.20	— — —	V
Low-level input voltage	V _{IL}	—		2.0 4.5 6.0	— — —	— — —	0.50 1.35 1.80	— — —	0.50 1.35 1.80	V
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	2.0	—	1.9	—	V
				4.5	4.4	4.5	—	4.4	—	
			I _{OH} = -4 mA I _{OH} = -5.2 mA	6.0	5.9	6.0	—	5.9	—	
				4.5	4.18	4.31	—	4.13	—	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0	—	0.0	0.1	—	0.1	V
				4.5	—	0.0	0.1	—	0.1	
			I _{OL} = 4 mA I _{OL} = 5.2 mA	6.0	—	0.0	0.1	—	0.1	
				4.5	—	0.17	0.26	—	0.33	
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		6.0	—	—	4.0	—	40.0	μA
				6.0	—	—	4.0	—	40.0	μA

AC Characteristics ($C_L = 15 \text{ pF}$, $V_{CC} = 5 \text{ V}$, $T_a = 25^\circ\text{C}$, input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Output transition time	t_{TLH} t_{THL}	—	—	4	8	ns
Propagation delay time (A, B- $\bar{Y}$)	t_{PLH} t_{PHL}	—	—	12	22	ns
Propagation delay time ($\bar{G}$ - $\bar{Y}$)	t_{PLH} t_{PHL}	—	—	10	18	ns

AC Characteristics ($C_L = 50 \text{ pF}$, input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	$T_a = 25^\circ\text{C}$			$T_a = -40\sim 85^\circ\text{C}$		Unit
			V_{CC} (V)	Min	Typ.	Max	Min	Max
Output transition time	t_{TLH} t_{THL}	—	2.0	—	30	75	—	95
			4.5	—	8	15	—	19
			6.0	—	7	13	—	16
Propagation delay time (A, B- $\bar{Y}$)	t_{PLH} t_{PHL}	—	2.0	—	45	130	—	165
			4.5	—	15	26	—	33
			6.0	—	13	22	—	28
Propagation delay time ($\bar{G}$ - $\bar{Y}$)	t_{PLH} t_{PHL}	—	2.0	—	39	110	—	140
			4.5	—	13	22	—	28
			6.0	—	11	19	—	24
Input capacitance	C_{IN}	—	—	—	5	10	—	10
Power dissipation capacitance	C_{PD} (Note)	—	—	—	46	—	—	—

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

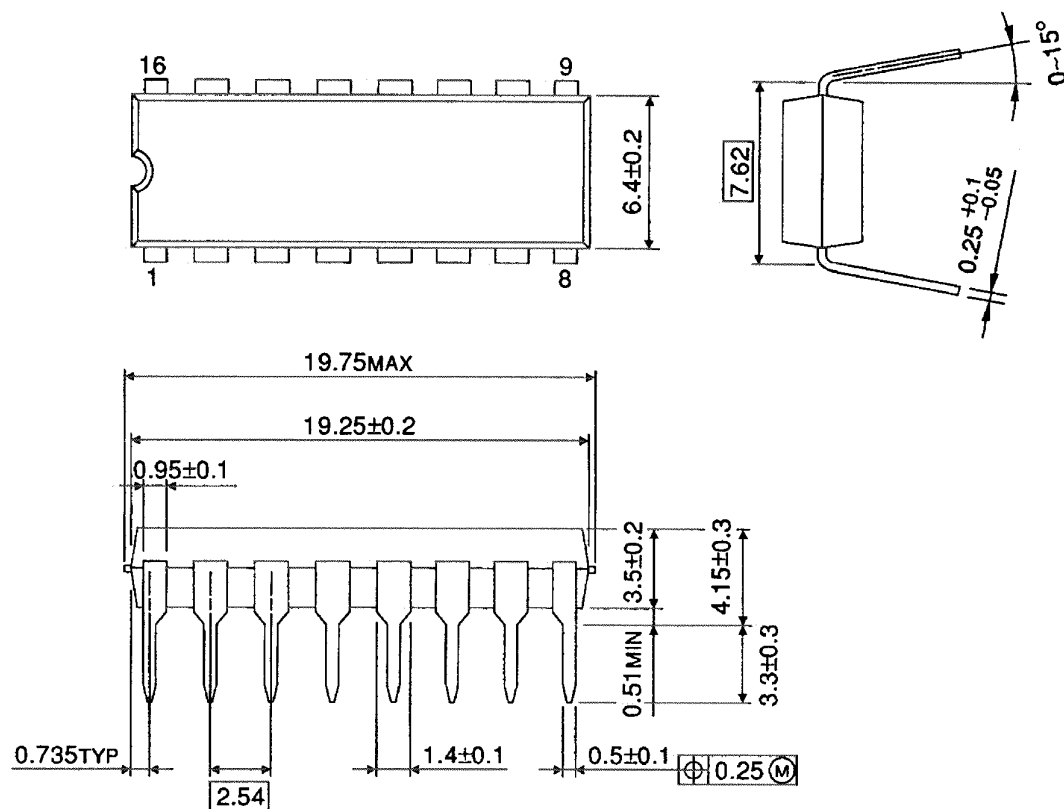
Average operating current can be obtained by the equation:

$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per decoder)}$$

Package Dimensions

DIP16-P-300-2.54A

Unit : mm

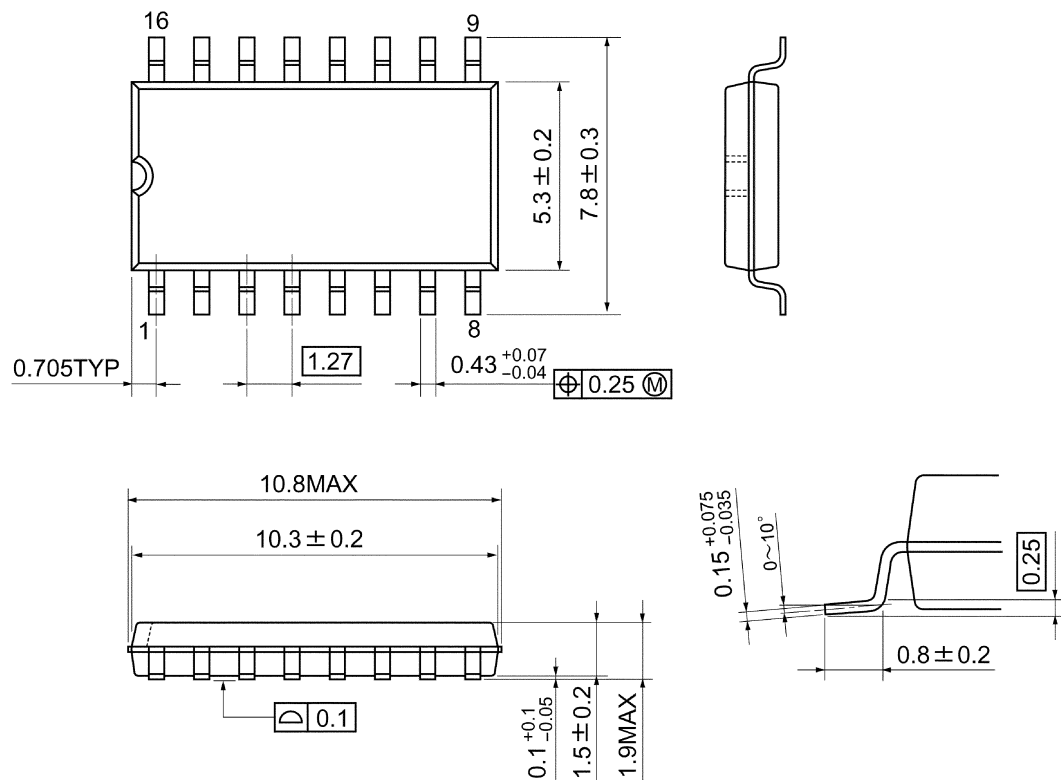


Weight: 1.00 g (typ.)

Package Dimensions

SOP16-P-300-1.27A

Unit: mm

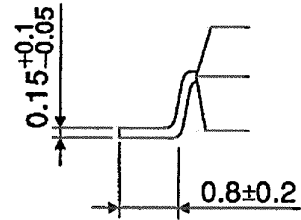
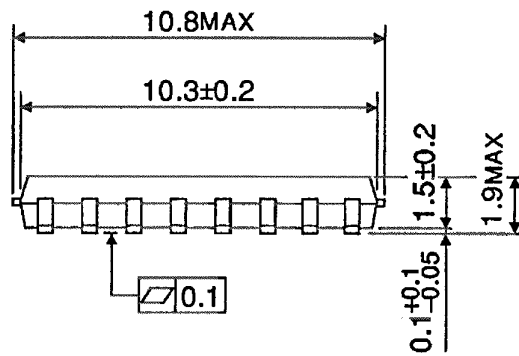
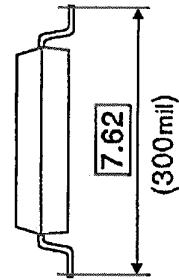


Weight: 0.18 g (typ.)

SOP16-P-300-1.27

Technical drawing of a rectangular component with dimensions and tolerances. The drawing shows a top view of the component, which is rectangular with a semi-circular notch on the left side. The dimensions are as follows:

- Overall width: 7.8 ± 0.3
- Overall height: 5.3 ± 0.2
- Distance from the left edge to the first hole: 0.705 TYP
- Distance between the first and second holes: 1.27
- Distance between the last two holes: 0.43 ± 0.1
- Distance from the right edge to the last hole: 0.25 (M)
- Number of holes on the top edge: 16
- Number of holes on the bottom edge: 8

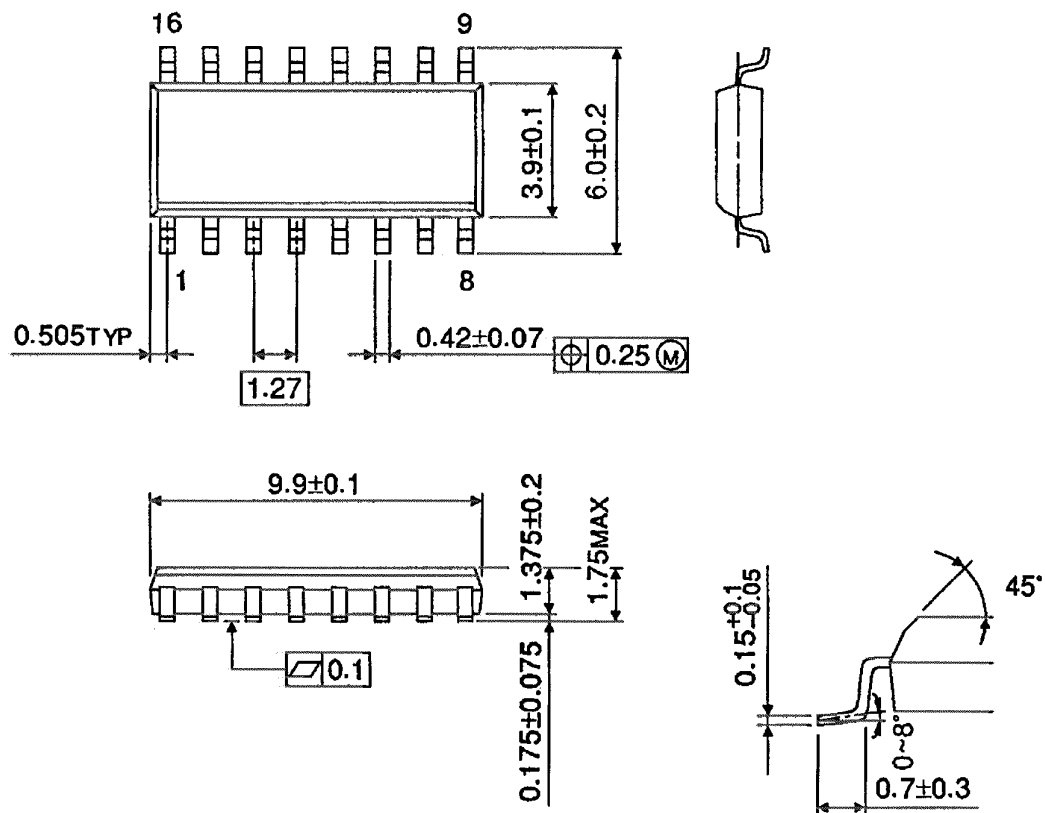


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Package Dimensions (Note)

SOL16-P-150-1.27

Unit : mm



Note: This package is not available in Japan.

Weight: 0.13 g (typ.)

Note: Lead (Pb)-Free Packages

DIP16-P-300-2.54A SOP16-P-300-1.27A SOL16-P-150-1.27

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